

CRST065N08N, CRSS063N08N

SkyMOS1 N-MOSFET 85V, $5.6m\Omega$, 80A

Features

- Uses CRM(CQ) advanced SkyMOS1 technology
- Extremely low on-resistance R_{DS(on)}
- Excellent Q_qxR_{DS(on)} product(FOM)
- Qualified according to JEDEC criteria

Product Summary

V_{DS}	85V
R _{DS(on)}	5.6mΩ
I _D	80A

Applications

- Motor control and drive
- Battery management
- UPS (Uninterrupible Power Supplies)

100% Avalanche Tested



Package Marking and Ordering Information

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRST065N08N	-	TO-220	Tube	N/A	N/A	50pcs
CRSS063N08N	-	TO-263	Tube	N/A	N/A	50pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	85	V
Continuous drain current			
$T_C = 25$ °C (Silicon limit)	I_D	121	Α
$T_C = 25$ °C (Package limit)	1 _D	80	
$T_C = 100$ °C (Silicon limit)		77	
Pulsed drain current ($T_C = 25$ °C, t_p limited by T_{jmax})	${ m I}_{ m D\ pulse}$	320	Α
Avalanche energy, single pulse (L=0.5mH, Rg=25 Ω)	E _{AS(Note 1)}	110	mJ
Gate-Source voltage	V_{GS}	±20	V
Power dissipation ($T_C = 25$ °C)	P _{tot}	164	W
Operating junction and storage temperature	T_{j} , T_{stg}	-55+150	°C

%. Notes:1.EAS is tested at starting Tj = 25°C, L = 0.5mH, IAS = 21A, VGS = 10V. IAS(max)=42A;EAS(max)=441mJ under above Conditions;





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Thermal Resistance

Parameter	Symbol	Max	Unit
Thermal resistance, junction – case.	R_{thJC}	0.76	°C/W
Thermal resistance, junction – ambient(min. footprint)	R_{thJA}	65	3 C/ VV

Electrical Characteristic (at Tj = 25 °C, unless otherwise specified)

Davameter	Cymhol	Value			11	Tank Canadikian
Parameter	Symbol	min.	typ.	max.	Unit	Test Condition
Static Characteristic						
Drain-source breakdown voltage	BV _{DSS}	85	97	-	V	V _{GS} =0V, I _D =250uA
Gate threshold voltage	V _{GS(th)}	2	3	4	V	$V_{DS}=V_{GS}$, $I_{D}=250$ uA
Zero gate voltage drain current	I_{DSS}	-	0.05	1	μΑ	V_{DS} =80V, V_{GS} =0V T_{j} =25°C
		ı	-	5		T _j =125°C
Gate-source leakage current	I_{GSS}	ı	10	100	nA	$V_{GS}=\pm 20V, V_{DS}=0V$
						V_{GS} =10V, I_D =50A
Drain-source on-state resistance	R _{DS(on)}	-	5.6	6.5	mΩ	TO-220
		-	5.4	6.3	11122	TO-263
Transconductance	g _{fs}	-	70	-	S	$V_{DS}=5V,I_{D}=40A$

Dynamic Characteristic

Input Capacitance	C _{iss}	_	2860	_		
- Input cupaciturice			2000			V_{GS} =0V, V_{DS} =42.5V, f =1MHz
Output Capacitance	C_{oss}	-	790	-	pF	
Reverse Transfer Capacitance	C _{rss}	-	19	-	•	
Gate Total Charge	Q_{G}	-	47	-		
Gate-Source charge	Q_{gs}	-	13	-	nC	V_{GS} =10V, V_{DS} =40V, I_{D} =50A, f=1MHz
Gate-Drain charge	Q_{gd}	-	11	-		
Turn-on delay time	t _{d(on)}	-	16	-		Vds=42.5V
Rise time	t _r	-	31	-	ns	Id=10A $Rg=3.5\Omega$ Vgs=10V;
Turn-off delay time	$t_{d(off)}$	-	36	-	115	
Fall time	t _f	_	19	_		(Note 2,3)
Gate resistance	R_G	-	3.3	-	Ω	V_{GS} =0V, V_{DS} =0V, f =1MHz





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Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition	
Parameter	Symbol	min.	typ.	max.	Oilit	rest Condition	
Body Diode Forward Voltage	V_{SD}	ı	0.9	1.4	V	V _{GS} =0V,I _{SD} =50A	
Body Diode Reverse Recovery Time	t _{rr}	-	56	-	ns	IS=30A, VGS=0V, dIF/dt=100A/us;	
Body Diode Reverse Recovery Charge	Q _{rr}	-	54	-	nC		

^{※.} Notes



^{2.}Pulse Test : Pulse Width \leq 300us, duty cycle \leq 2%.

^{3.} Essentially independent of operating temperature.



Typical Performance Characteristics

Fig 1: Output Characteristics 300 Vgs#9V.10V 1. 250µs Pulse Test From Bottom To Top 250 2. T_i=25 °C lo, Drain Current (A) Vgs#8V 200 Vgs=7V 150 100 Vas≕6V 50 Vgs≓5V 0

Vps, Drain To Source Voltage (V)

12

Fig 2: Transfer Characteristics

300
VDS=5V
Tj=25 ©
Tj=125 ©
Tj=12

Gate To Source Voltage (V)

Fig 3: Rds(on) vs Drain Current and Gate Voltage 7.0 6.0 R_{DS(on)} (mΩ) 5.0 V_{GS}=10V 4.0 3.0 2.0 10 40 70 90 100 20 30 50 60 80 $I_D(A)$

Fig 4: Rds(on) vs Gate Voltage

10⁰

10⁻¹

10⁻²

10⁻³

2

4

6

8

10

V_{GS}(V)

Fig 5: Rds(on) vs. Temperature 2.0 $V_{GS}=10V$ 1.8 $I_D = 50A$ R_{DS(on)}_Normalized 1.6 1.4 1.2 1.0 0.8 0.6 0.4 25 75 150 175 Tj - Junction Temperature (°C)

Fig 6: Capacitance Characteristics 10000 Ciss C - Capacitance (PF) Coss 1000 100 $V_{GS}=0V$ Crss f=1MHz 10 0 10 20 30 40 50 V_{DS} (V)

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Fig 7: Gate Charge Characteristics

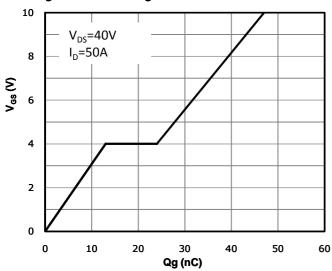


Fig 8: Body-diode Forward Characteristics

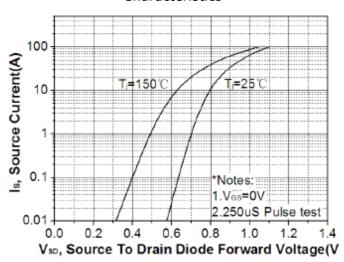


Fig 9: Power Dissipation

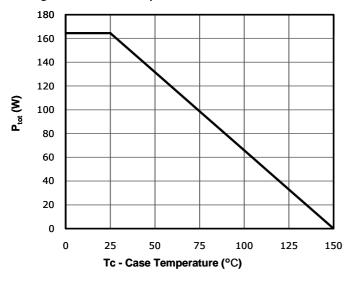


Fig 10: Drain Current Derating

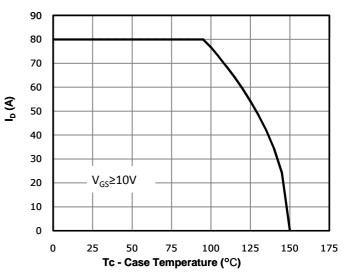
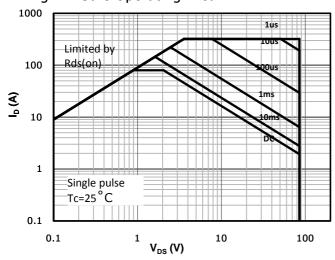


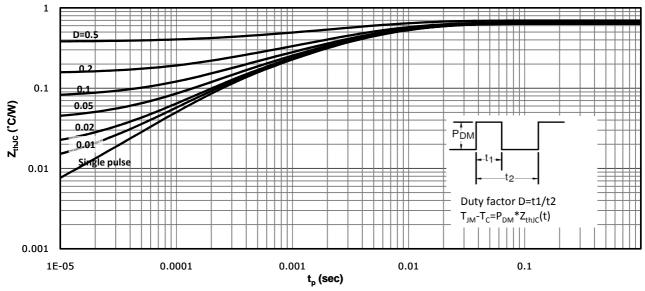
Fig 11: Safe Operating Area





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Fig 12: Max. Transient Thermal Impedance

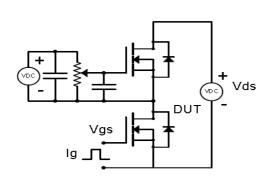


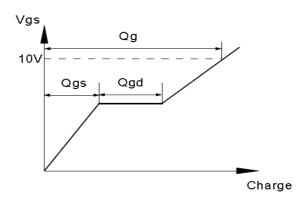


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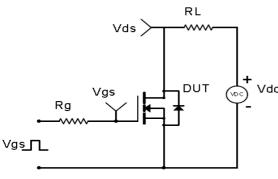
Test Circuit & Waveform

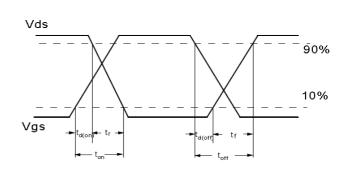
Gate Charge Test Circuit & Waveform



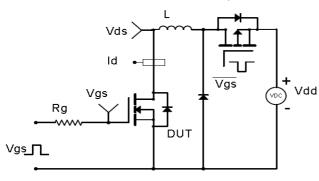


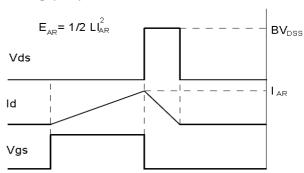
Resistive Switching Test Circuit & Waveforms



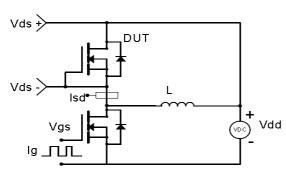


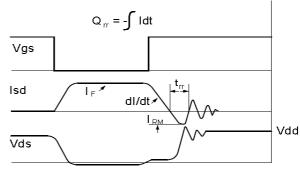
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

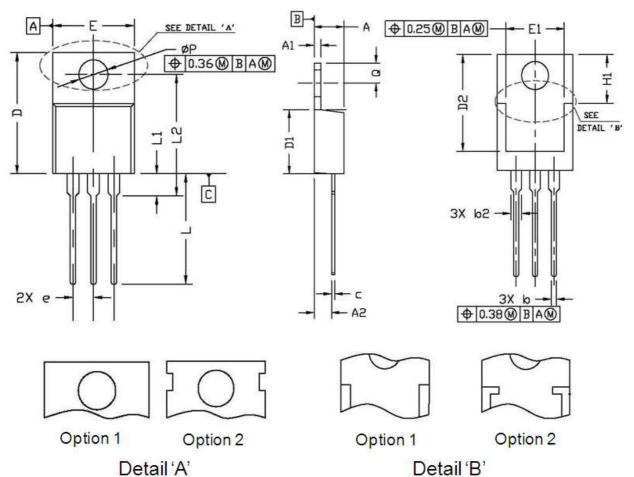






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Package Outline: TO-220-3L



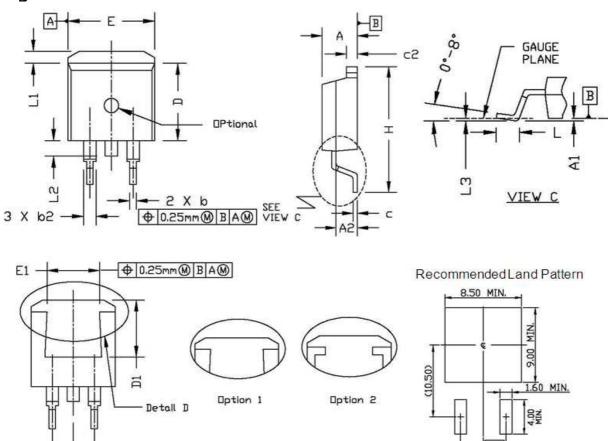
Sumah al	Dimensions I	n Millimeters	Dimension	ns In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.30	4.80	0.169	0.189
A1	1.20	1.45	0.047	0.057
A2	2.20	2.90	0.087	0.114
b	0.69	0.95	0.027	0.037
b2	1.00	1.60	0.039	0.063
С	0.33	0.65	0.013	0.026
D	14.70	16.20	0.579	0.638
D1	8.59	9.65	0.338	0.380
D2	11.75	13.60	0.463	0.535
е	2.54	2.54 BSC.		0 BSC.
Е	9.60	10.60	0.378	0.417
E1	7.00	8.46	0.276	0.333
H1	6.20	7.00	0.244	0.276
L	12.60	14.80	0.496	0.583
L1	2.70	3.80	0.106	0.150
L2	12.13	16.50	0.478	0.650
Q	2.40	3.10	0.094	0.122
Р	3.50	3.90	0.138	0.154



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Package Outline: TO-263

2 X e



DETAIL D

Symbol	Dimensions In Millimeters		Dimension	ns In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.30	4.86	0.169	0.191
A1	0.00	0.25	0.000	0.010
A2	2.34	2.79	0.092	0.110
b	0.68	0.94	0.027	0.037
b2	1.15	1.35	0.045	0.053
С	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.38	9.45	0.330	0.372
D1	6.90	8.17	0.272	0.322
е	2.54 BSC.		0.100 BSC.	
E	9.78	10.50	0.385	0.413
E1	6.50	8.60	0.256	0.339
Н	14.61	15.88	0.575	0.625
L	2.24	3.00	0.088	0.118
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
L3	0.00	0.25	0.000	0.010



UNIT: mm



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Revision History

Revison	Date	Major changes
1.0	2018-02-09	Release of formal version.
2.0	2019-05-28	Supplement package outline info.

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qulified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semicondutor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.

